



15V ULTRA LOW CAPACITANCE BIDIRECTIONAL TVS DIODE

Product Summary

V _{BR} (Min)	IPP (Max)	С⊤ (Тур)
16.5V	5A	0.55pF

Description

This new generation TVS is designed to protect sensitive electronics from the damage due to ESD. The combination of small size and high ESD surge capability makes it ideal for use in portable applications such as cellular phones, digital cameras, and MP3 players.

Applications

- Cellular Handsets
- Portable Electronics
- Computers and Peripheral

Features

- Low Profile Package (0.53mm Max) and Ultra-Small PCB Footprint Area (1.08mm x 0.68mm Max) Suitable for Compact Portable Electronics
- Provides ESD Protection per IEC 61000-4-2 Standard: Air ±24kV, Contact ±20kV
- One Channel of ESD Protection
- Low Channel Input Capacitance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: X1-DFN1006-2
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208 ℯ₄
- Weight: 0.001 grams (Approximate)

X1-DFN1006-2

Bottom View

• **► \ ** • •

Device Schematic

Ordering Information (Note 4)

Part Number	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
D15V0X1B2LP-7B	Standard	ZH	7	8	10,000/Tape & Reel
Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.					

No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
 See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and

Lead-free. 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information

ZH

ZH = Product Type Marking Code Bar Denotes Pin 1



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Current	IPP	5	A	8/20µs, See Figure 3
ESD Protection – Contact Discharge	Vesd_contact	±20	kV	IEC 61000-4-2 Standard
ESD Protection – Air Discharge	V_{ESD} Air	±24	kV	IEC 61000-4-2 Standard

Thermal Characteristics

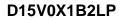
Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 5)	PD	250	mW
Thermal Resistance, Junction to Ambient (Note 5)	R _{θJA}	500	°C/W
Operating and Storage Temperature Range	TJ, T _{STG}	-65 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Working Voltage	V _{RWM}	_	—	15.0	V	—
Reverse Current (Note 6)	I _R	_	_	1	μA	V _R = 15.0V
Reverse Breakdown Voltage	V _{BR}	16.5	_	—	V	I _R = 1mA
Reverse Clamping Voltage, Positive Transients	V _{CL}		—	28	V	I _{PP} = 1A, t _P = 8/20μs
		_	—	30	V	I _{PP} = 5A, t _P = 8/20μs
Dynamic Resistance	R _{DYN}	_	0.6	—	Ω	I _R = 1A, t _P = 8/20µs
Capacitance	CT		0.55	0.7	pF	$V_R = 0V$, f = 1MHz

 Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes Incorporated's suggested pad layout per http://www.diodes.com/package-outlines.html.
 Short duration pulse test used to minimize self-heating effect. Notes:





175 200

25

30

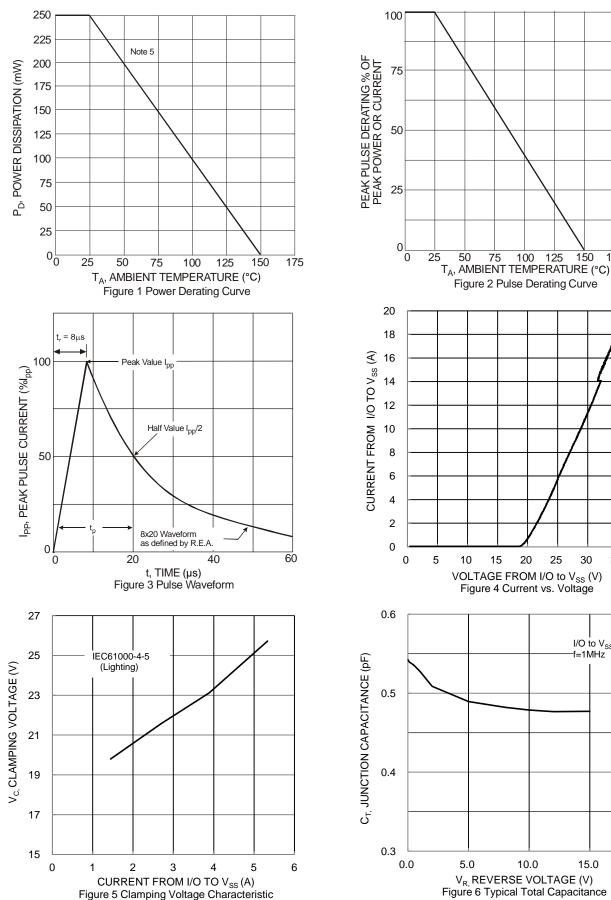
I/O to V_{SS}

f=1MHz

15.0

35

40

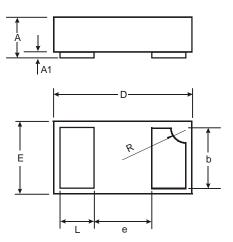


20.0



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

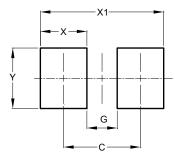


X1-DFN1006-2						
Dim	Min	Max	Тур			
Α	0.47	0.53	0.50			
A1	0	0.05	0.03			
b	0.45	0.55	0.50			
D	0.95	1.075	1.00			
Е	0.55	0.675	0.60			
е	-	-	0.40			
L	0.20	0.30	0.25			
R	0.05	0.15	0.10			
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.





Dimensions	Value (in mm)		
С	0.70		
G	0.30		
Х	0.40		
X1	1.10		
Y	0.70		

X1-DFN1006-2



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